

## Low On-Resistance Wideband/Video Dual 4-Channel Mux/DeMux

#### **Features**

High-performance, low-cost solution to switch between video sources

Wide bandwidth: 150 MHz
Low On-Resistance: 3Ω

• Low crosstalk at 10 MHz: -58dB

• Ultra-low quiescent power (0.1 µA typical)

• Single supply operation: +5.0V

• Fast switching: 10ns

• High-current output: 100mA

• Functionally equivalent to QS4A210

• Packaging (Pb-free & Green available):

- 16-pin 150-mil-wide plastic QSOP (Q)

- 16-pin 150-mil-wide plastic SOIC (W)

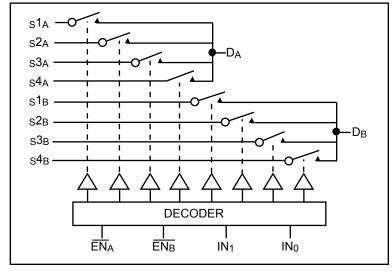
### **Description**

Pericom Semiconductor's PI5V331 is a true bidirectional Dual 4-channel multiplexer/demultiplexer that is recommended for both S-Video or composite video switching applications. The switch can be driven from a current output RAMDAC or voltage output composite video source.

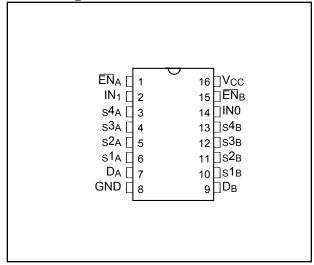
Low On-resistance and wide bandwidth make it ideal for video and other applications. Also this device has exceptionally high current capability which is far greater than most analog switches offered today. A single 5V supply is all that is required for operation.

The PI5V331 offers a high-performance, low-cost solution to switch between video sources.

## **Block Diagram**



### Pin Configuration



### **Truth Table**

$\overline{\mathrm{EN}}_{\mathrm{A}}$	$\overline{\mathrm{EN}}_{\mathrm{B}}$	IN <sub>1</sub>	$IN_0$	On Switch
1	X	X	X	Disable A
X	1	X	X	Disable B
0	0	0	0	$s1_A - D_A$ , $s1_B - D_B$
0	0	0	1	s2 <sub>A</sub> - D <sub>A</sub> , s2 <sub>B</sub> - D <sub>B</sub>
0	0	1	0	s3 <sub>A</sub> - D <sub>A</sub> , s3 <sub>B</sub> - D <sub>B</sub>
0	0	1	1	s4 <sub>A</sub> - D <sub>A</sub> , s4 <sub>B</sub> - D <sub>B</sub>

### **Pin Description**

1

Pin Name	Description
S1A, S2A, S3A, S4A S1B, S2B, S3B, S4B	Analog Video I/O (Usually Inputs)
$S_0, S_1$	Select Input
$\overline{EN}_A, \overline{EN}_B$	Enable
$D_A, D_B$	Analog Video I/O (Usually Outputs)
GND	Ground
V <sub>CC</sub>	Power

PS8117B 09/13/04



### **Maximum Ratings**

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature—65°C to +150°C
Ambient Temperature with Power Applied—40°C to +85°C
Supply Voltage to Ground Potential (Inputs & V <sub>CC</sub> Only)–0.5V to +7.0V
Supply Voltage to Ground Potential (Outputs & D/O Only) –0.5V to +7.0V
DC Input Voltage0.5V to +7.0V
DC Output Current
Power Dissipation

#### Note:

Stresses greater than those listed under MAXIMUM RAT-INGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

### **DC Electrical Characteristics** (Over the Operating Range, $T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ , $V_{CC} = 5\text{V} \pm 5\%$ )

Parameters	Description	Test Conditions <sup>(1)</sup>	Min.	<b>Typ</b> <sup>(2)</sup>	Max.	Units	
V <sub>ANALOG</sub>	Analog Signal Range		0	_	2.0		
$V_{\mathrm{IH}}$	Input HIGH Voltage	Guaranteed Logic HIGH Level	2.0	_	_	V	
$V_{\mathrm{IL}}$	Input LOW Voltage	Guaranteed Logic LOW Level	-0.5	_	0.8		
$I_{\mathrm{IH}}$	Input HIGH Current	$V_{CC} = Max., V_{IN} = V_{CC}$	_	_	±1		
$I_{IL}$	Input LOW Current	$V_{CC} = Max., V_{IN} = GND$	_	_	±1	μΑ	
I <sub>O</sub>	Analog Output Leakage Current	$0 \le S_1$ , $S_2$ or $D \le V_{CC}$ , Switch Off	_	_	±1	μΑ	
$V_{IK}$	Clamp Diode Voltage	$V_{CC} = Min., I_{IN} = -18 \text{ mA}$	_	-0.7	-1.2	V	
Ios	Short Circuit Current <sup>(3)</sup>	$S_1, S_2, D = 0V V_{CC}$	100	_	_	mA	
$V_{\mathrm{H}}$	Input Hysteresis at Control Pins		_	150	—	mV	
R <sub>ON</sub>	Switch On-Resistance <sup>(4)</sup>	$V_{CC} = Min., V_{OUT} = 0.975V,$ $R_L = 75\Omega, I_{ON} = 13 \text{ mA}$		3	7	Ω	
		$V_{CC} = M_{IN.}, V_{OUT} = 1.95V,$ $R_L = 75\Omega, I_{ON} = 26 \text{ mA}$		7	10	7.2	

#### **Notes:**

- 1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at  $V_{CC} = 5.0V$ ,  $T_A = 25^{\circ}C$  ambient and maximum loading.
- 3. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
- 4. Measured by the voltage drop between  $S_1$ ,  $S_2$ , and D I/O pins at indicated current through the switch. On-Resistance is determined by the lower of the voltages on the  $S_1$ ,  $S_2$ , and D I/O pins.  $V_{OUT}$  is the voltage across  $R_L$ .

2



### **Dynamic Characteristics** (Over the Operating Range, $T_A = -40$ °C to +85°C, $V_{CC} = 5V \pm 5\%$ )

Parameter	Description	Test Conditions	Min.	Тур.	Max.	Units
ton	Turn On Time	$R_L = 75\Omega$ , $C_L = 20$ pF, see Fig. 2	_	2.5	5	<b>10</b> G
t <sub>OFF</sub>	Turn Off Time	$R_L = 75\Omega$ , $C_L = 20$ pF, see Fig. 2	_	1.1	5	ns
Bw <sup>(1)</sup>	-3 dB Bandwidth	$R_L = 150\Omega$ , see Fig. 3	150	_		MHz
X <sub>TALK</sub>	Crosstalk	$R_{IN} = 10\Omega$ ; $R_L = 150\Omega$ , 10 MHz, see Fig. 3	_	-58	_	dB
$D_G$	Differential Gain	$R_L = 150\Omega$ , $f = 3.58$ MHz, see Fig. 1	_	0.64		%
$D_P$	Differential Phase	$R_L = 150\Omega$ , $f = 3.58$ MHz, see Fig. 1	_	0.27		Deg.
$C_{IN}^{(1)}$	Input/Enable Capacitance	$V_{IN} = 0V$ , $f = 1 MHz$	_	_	6	
C <sub>OFF</sub> <sup>(1)</sup>	Capacitance, Switch Off	$V_{IN} = 0V$ , $f = 1 MHz$	_	_	6	pF
$C_{ON}^{(1)}$	Capacitance, Switch On	$V_{IN} = 0V$ , $f = 1 MHz$	_	_	20	
O <sub>IRR</sub>	Off Isolation	$R_L = 150\Omega$ , 10 MHz, see Fig. 3	_	-38	_	dB

#### Notes:

### **Power Supply Characteristics**

Parameters	Description	Test Conditions <sup>(1)</sup>		Min.	<b>Typ</b> <sup>(2)</sup>	Max.	Units
I <sub>CC</sub>	Quiescent Power Supply Current	$V_{CC} = Max.$	$IN = GND \text{ or } V_{CC}$	_	0.1	3.0	μΑ
$\Delta I_{CC}$	Supply Current per Input @ TTL HIGH	$V_{CC} = Max.$	$IN = 3.4V^{(3)}$			2.5	mA
I <sub>CCD</sub>	Supply Current per Input per MHz <sup>(4)</sup>	$V_{CC} = Max.,$ $S_1, S_2, \text{ and D Pins Open}$ $\overline{EN} = GND$ Control Input Toggling 50% Duty Cycle		_	_	0.25	mA/ MHz

### Notes:

- 1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
- 2. Typical values are at  $V_{CC} = 5.0V$ ,  $+25^{\circ}C$  ambient.
- 3. Per TTL driven input ( $V_{IN} = 3.4V$ , control inputs only);  $S_1$ ,  $S_2$ , and D pins do not contribute to Icc.
- 4. This current applies to the control inputs only and represent the current required to switch internal capacitance at the specified frequency. The S<sub>1</sub>, S<sub>2</sub>, and D I/O pins generate no significant AC or DC currents as they transition. This parameter is not tested, but is guaranteed by design.

3

PS8117B 09/13/04

<sup>1.</sup> This parameter is determined by device characterization but is not production tested.



# **Definitions**

Symbol	Description			
R <sub>ON</sub>	Resistance between source and drain with switch in the ON state.			
I <sub>O</sub>	Output leakage current measured at S <sub>1</sub> , S <sub>2</sub> , and D with the switch OFF.			
V <sub>IN</sub>	Digital voltage at the IN pin that selects between S <sub>1</sub> and S <sub>2</sub> analog inputs.			
$V_{EN}$	A voltage that ENABLES the chip.			
C <sub>IN</sub>	Capacitance at the digital inputs.			
C <sub>OFF</sub>	Capacitance at analog I/O (S <sub>1</sub> , S <sub>2</sub> , D) with switch OFF.			
C <sub>ON</sub>	Capacitance at analog I/O (S <sub>1</sub> , S <sub>2</sub> , D) with switch ON.			
$V_{\mathrm{IH}}$	Minimum input voltage for logic HIGH.			
V <sub>IL</sub>	Minimum input voltage for logic LOW.			
I <sub>IH</sub> (I <sub>IL</sub> )	Input current of the digital input.			
I <sub>OS</sub>	Minimum short circuit current for S <sub>1</sub> , S <sub>2</sub> and D.			
t <sub>ON</sub>	Propagation delay measured between 50% of the digital input to 90% of the analog output when switch is turned ON. The peak analog voltage is 0.714V.			
t <sub>OFF</sub>	Propagation delay measured between 50% of the digital input to 90% of the analog output when switch is turned OFF. The peak analog voltage is 0.714V.			
$B_{\mathrm{W}}$	Frequency response of the switch in the ON state measured at 3dB down.			
X <sub>TALK</sub>	Is an unwanted signal coupled from channel to channel. Measured in $-dB$ . $X_{TALK} = 20 \text{ LOG V}_{OUT}/V_{IN}$ . This is non-adjacent crosstalk.			
$D_{\mathrm{G}}$	Differential gain is the difference measurement between two bias levels, for instance analog input signals of 0V to 0.714V.			
D <sub>P</sub>	Differential phase is the difference measurement between two bias levels, for instance analog input signals of 0V to 0.714V.			
O <sub>IRR</sub>	Off isolation is the resistance (measured in –dB) between the input and output with the switch off (NO).			



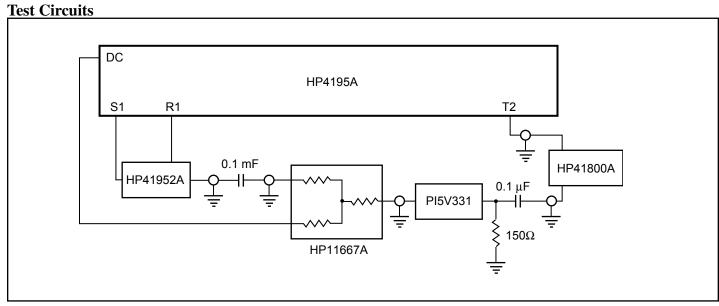


Figure 1. Differential Gain/Phase

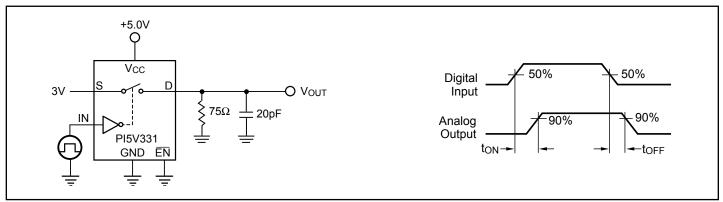


Figure 2. Switching Time

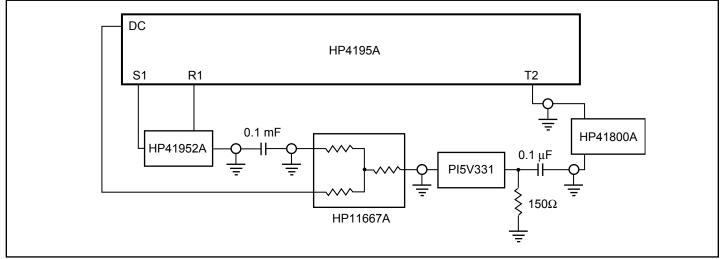
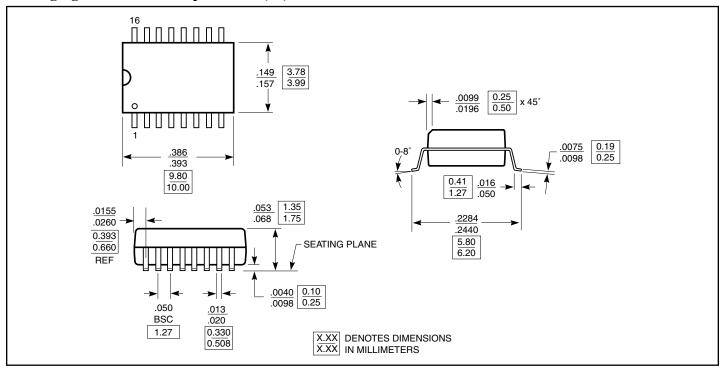


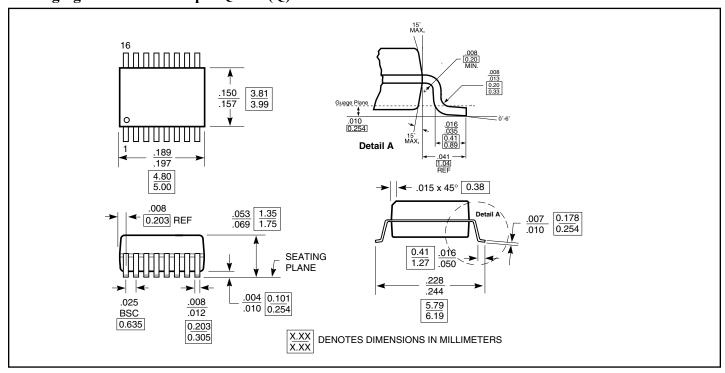
Figure 3. Gain/Phase, Crosstalk, Off-Isolation



## Packaging Mechanical: 16-pin SOIC (W)



### Packaging Mechanical: 16-pin QSOP (Q)





# **Ordering Information**

Ordering Code	Package Type	Package Description
PI5V331W	W	16-pin SOIC
PI5V331WE	W	Pb-free & Green, 16-pin SOIC
PI5V331Q	Q	16-pin QSOP
PI5V331QE	Q	Pb-free & Green, 16-pin QSOP

#### **Notes:**

<sup>1.</sup> Thermal characteristics can be found on the company web site at www.pericom.com/packaging/